

# MC74LCX245

## Low-Voltage CMOS Octal Transceiver

### With 5 V-Tolerant Inputs and Outputs (3-State, Non-Inverting)

The MC74LCX245 is a high performance, non-inverting octal transceiver operating from a 2.0 to 5.5 V supply. High impedance TTL compatible inputs significantly reduce current loading to input drivers while TTL compatible outputs offer improved switching noise performance. A  $V_I$  specification of 5.5 V allows MC74LCX245 inputs to be safely driven from 5 V devices if  $V_{CC}$  is less than 5.0 V. The MC74LCX245 is suitable for memory address driving and all TTL level bus oriented transceiver applications.

Current drive capability is 24 mA at both A and B ports. The Transmit/Receive ( $T/\bar{R}$ ) input determines the direction of data flow through the bi-directional transceiver. Transmit (active-HIGH) enables data from A ports to B ports; Receive (active-LOW) enables data from B to A ports. The Output Enable input, when HIGH, disables both A and B ports by placing them in a HIGH Z condition.

#### Features

- Designed for 2.0 to 5.5 V  $V_{CC}$  Operation
- 5 V Tolerant – Interface Capability With 5 V TTL Logic
- Supports Live Insertion and Withdrawal
- $I_{OFF}$  Specification Guarantees High Impedance When  $V_{CC} = 0$  V
- LVTTL Compatible
- LVCMOS Compatible
- 24 mA Balanced Output Sink and Source Capability
- Near Zero Static Supply Current in All Three Logic States (10  $\mu$ A)  
Substantially Reduces System Power Requirements
- Latchup Performance Exceeds 500 mA
- ESD Performance: Human Body Model >2000 V  
Machine Model >200 V
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

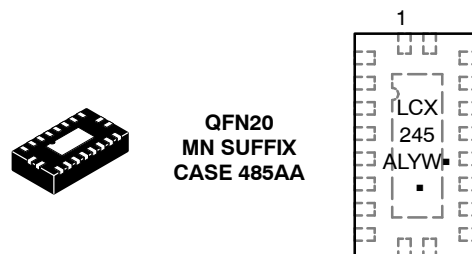
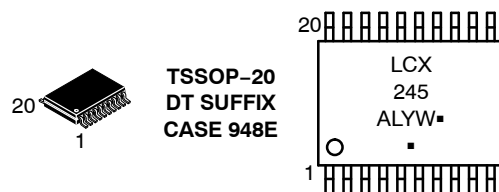
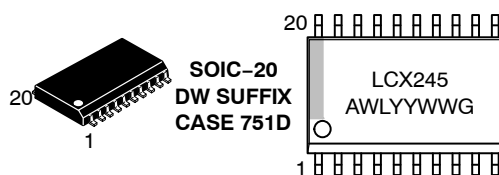
\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



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#### MARKING DIAGRAMS



A = Assembly Location  
L, WL = Wafer Lot  
Y, YY = Year  
W, WW = Work Week  
G or ▪ = Pb-Free Package

(Note: Microdot may be in either location)

#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 6 of this data sheet.

# MC74LCX245

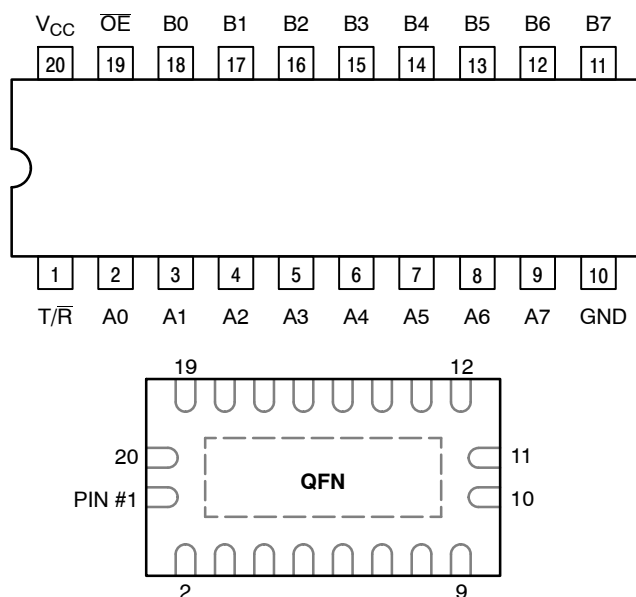


Figure 1. Pinout (Top View)

## PIN NAMES

| PINS            | FUNCTION                                 |
|-----------------|------------------------------------------|
| $\overline{OE}$ | Output Enable Input                      |
| T/R             | Transmit/Receive Input                   |
| A0–A7           | Side A 3–State Inputs or 3–State Outputs |
| B0–B7           | Side B 3–State Inputs or 3–State Outputs |

## TRUTH TABLE

| INPUTS          |     | OPERATING MODE<br>Non-Inverting |
|-----------------|-----|---------------------------------|
| $\overline{OE}$ | T/R |                                 |
| L               | L   | B Data to A Bus                 |
| L               | H   | A Data to B Bus                 |
| H               | X   | Z                               |

H = High Voltage Level

L = Low Voltage Level

Z = High Impedance State

X = High or Low Voltage Level and Transitions are Acceptable

For  $I_{CC}$  reasons, Do Not Float Inputs

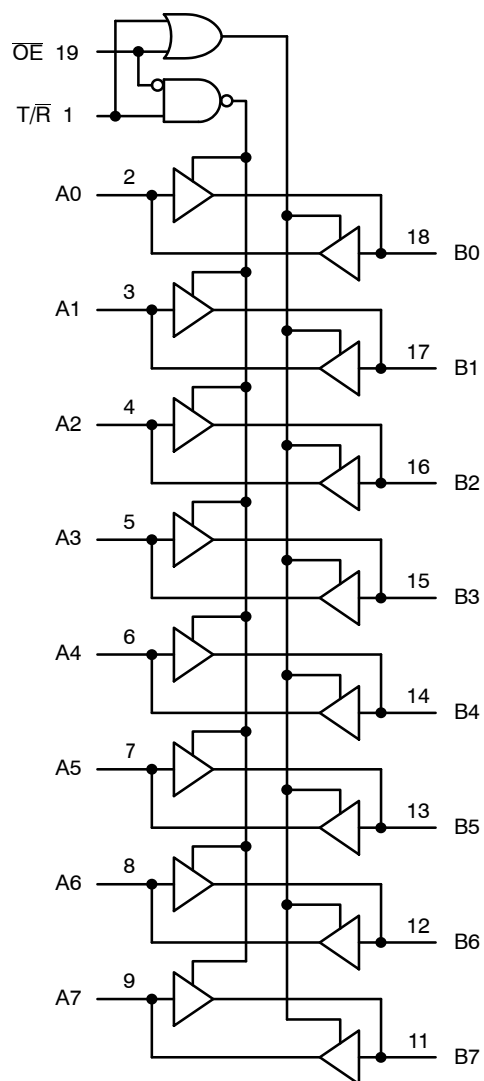


Figure 2. Logic Diagram

# MC74LCX245

## MAXIMUM RATINGS

| Symbol    | Parameter                        | Value                             | Condition                            | Unit |
|-----------|----------------------------------|-----------------------------------|--------------------------------------|------|
| $V_{CC}$  | DC Supply Voltage                | -0.5 to +7.0                      |                                      | V    |
| $V_I$     | DC Input Voltage                 | $-0.5 \leq V_I \leq +7.0$         |                                      | V    |
| $V_O$     | DC Output Voltage                | $-0.5 \leq V_O \leq +7.0$         | Output in 3-State                    | V    |
|           |                                  | $-0.5 \leq V_O \leq V_{CC} + 0.5$ | Output in HIGH or LOW State (Note 1) | V    |
| $I_{IK}$  | DC Input Diode Current           | -50                               | $V_I < GND$                          | mA   |
| $I_{OK}$  | DC Output Diode Current          | -50                               | $V_O < GND$                          | mA   |
|           |                                  | +50                               | $V_O > V_{CC}$                       | mA   |
| $I_O$     | DC Output Source/Sink Current    | $\pm 50$                          |                                      | mA   |
| $I_{CC}$  | DC Supply Current Per Supply Pin | $\pm 100$                         |                                      | mA   |
| $I_{GND}$ | DC Ground Current Per Ground Pin | $\pm 100$                         |                                      | mA   |
| $T_{STG}$ | Storage Temperature Range        | -65 to +150                       |                                      | °C   |
| MSL       | Moisture Sensitivity             |                                   | Level 1                              |      |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1.  $I_O$  absolute maximum rating must be observed.

## RECOMMENDED OPERATING CONDITIONS

| Symbol          | Parameter                                                                                                                          | Min        | Typ                  | Max                    | Unit |
|-----------------|------------------------------------------------------------------------------------------------------------------------------------|------------|----------------------|------------------------|------|
| V <sub>CC</sub> | Supply Voltage<br>Operating<br>Data Retention Only                                                                                 | 2.0<br>1.5 | 2.5, 3.3<br>2.5, 3.3 | 5.5<br>5.5             | V    |
| V <sub>I</sub>  | Input Voltage                                                                                                                      | 0          |                      | 5.5                    | V    |
| V <sub>O</sub>  | Output Voltage (HIGH or LOW State)<br>(3-State)                                                                                    | 0<br>0     |                      | V <sub>CC</sub><br>5.5 | V    |
| I <sub>OH</sub> | HIGH Level Output Current<br>V <sub>CC</sub> = 3.0 V – 3.6 V<br>V <sub>CC</sub> = 2.7 V – 3.0 V<br>V <sub>CC</sub> = 2.3 V – 2.7 V |            |                      | – 24<br>– 12<br>– 8    | mA   |
| I <sub>OL</sub> | LOW Level Output Current<br>V <sub>CC</sub> = 3.0 V – 3.6 V<br>V <sub>CC</sub> = 2.7 V – 3.0 V<br>V <sub>CC</sub> = 2.3 V – 2.7 V  |            |                      | + 24<br>+ 12<br>+ 8    | mA   |
| T <sub>A</sub>  | Operating Free-Air Temperature                                                                                                     | –55        |                      | +125                   | °C   |
| Δt/ΔV           | Input Transition Rise or Fall Rate, V <sub>IN</sub> from 0.8 V to 2.0 V, V <sub>CC</sub> = 3.0 V                                   | 0          |                      | 10                     | ns/V |

# MC74LCX245

## DC ELECTRICAL CHARACTERISTICS

| Symbol           | Characteristic                        | Condition                                                                                                        | T <sub>A</sub> = -55°C to +125°C |      | Unit |
|------------------|---------------------------------------|------------------------------------------------------------------------------------------------------------------|----------------------------------|------|------|
|                  |                                       |                                                                                                                  | Min                              | Max  |      |
| V <sub>IH</sub>  | HIGH Level Input Voltage (Note 2)     | 2.3 V ≤ V <sub>CC</sub> ≤ 2.7 V                                                                                  | 1.7                              |      | V    |
|                  |                                       | 2.7 V ≤ V <sub>CC</sub> ≤ 3.6 V                                                                                  | 2.0                              |      |      |
| V <sub>IL</sub>  | LOW Level Input Voltage (Note 2)      | 2.3 V ≤ V <sub>CC</sub> ≤ 2.7 V                                                                                  |                                  | 0.7  | V    |
|                  |                                       | 2.7 V ≤ V <sub>CC</sub> ≤ 3.6 V                                                                                  |                                  | 0.8  |      |
| V <sub>OH</sub>  | HIGH Level Output Voltage             | 2.3 V ≤ V <sub>CC</sub> ≤ 3.6 V; I <sub>OL</sub> = 100 μA                                                        | V <sub>CC</sub> - 0.2            |      | V    |
|                  |                                       | V <sub>CC</sub> = 2.3 V; I <sub>OH</sub> = -8 mA                                                                 | 1.8                              |      |      |
|                  |                                       | V <sub>CC</sub> = 2.7 V; I <sub>OH</sub> = -12 mA                                                                | 2.2                              |      |      |
|                  |                                       | V <sub>CC</sub> = 3.0 V; I <sub>OH</sub> = -18 mA                                                                | 2.4                              |      |      |
|                  |                                       | V <sub>CC</sub> = 3.0 V; I <sub>OH</sub> = -24 mA                                                                | 2.2                              |      |      |
| V <sub>OL</sub>  | LOW Level Output Voltage              | 2.3 V ≤ V <sub>CC</sub> ≤ 3.6 V; I <sub>OL</sub> = 100 μA                                                        |                                  | 0.2  | V    |
|                  |                                       | V <sub>CC</sub> = 2.3 V; I <sub>OL</sub> = 8 mA                                                                  |                                  | 0.6  |      |
|                  |                                       | V <sub>CC</sub> = 2.7 V; I <sub>OL</sub> = 12 mA                                                                 |                                  | 0.4  |      |
|                  |                                       | V <sub>CC</sub> = 3.0 V; I <sub>OL</sub> = 16 mA                                                                 |                                  | 0.4  |      |
|                  |                                       | V <sub>CC</sub> = 3.0 V; I <sub>OL</sub> = 24 mA                                                                 |                                  | 0.55 |      |
| I <sub>OZ</sub>  | 3-State Output Current                | V <sub>CC</sub> = 3.6 V, V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> ,<br>V <sub>OUT</sub> = 0 to 5.5 V |                                  | ±5   | μA   |
| I <sub>OFF</sub> | Power Off Leakage Current             | V <sub>CC</sub> = 0, V <sub>IN</sub> = 5.5 V or V <sub>OUT</sub> = 5.5 V                                         |                                  | 10   | μA   |
| I <sub>IN</sub>  | Input Leakage Current                 | V <sub>CC</sub> = 3.6 V, V <sub>IN</sub> = 5.5 V or GND                                                          |                                  | ±5   | μA   |
| I <sub>CC</sub>  | Quiescent Supply Current              | V <sub>CC</sub> = 3.6 V, V <sub>IN</sub> = 5.5 V or GND                                                          |                                  | 10   | μA   |
| ΔI <sub>CC</sub> | Increase in I <sub>CC</sub> per Input | 2.3 ≤ V <sub>CC</sub> ≤ 3.6 V; V <sub>IH</sub> = V <sub>CC</sub> - 0.6 V                                         |                                  | 500  | μA   |

2. These values of V<sub>I</sub> are used to test DC electrical characteristics only.

## AC CHARACTERISTICS t<sub>tr</sub> = t<sub>F</sub> = 2.5 ns; R<sub>L</sub> = 500 Ω

| Symbol                                 | Parameter                                      | Waveform | Limits                           |            |                         |            |                                |              |                         |            | Unit |
|----------------------------------------|------------------------------------------------|----------|----------------------------------|------------|-------------------------|------------|--------------------------------|--------------|-------------------------|------------|------|
|                                        |                                                |          | T <sub>A</sub> = -55°C to +125°C |            |                         |            |                                |              |                         |            |      |
|                                        |                                                |          | V <sub>CC</sub> = 3.3 V ± 0.3V   |            | V <sub>CC</sub> = 2.7 V |            | V <sub>CC</sub> = 2.5 V ± 0.2V |              | V <sub>CC</sub> = 5.0 V |            |      |
|                                        |                                                |          | C <sub>L</sub> = 50 pF           |            | C <sub>L</sub> = 50 pF  |            | C <sub>L</sub> = 30 pF         |              | C <sub>L</sub> = 50 pF  |            |      |
|                                        |                                                |          | Min                              | Max        | Min                     | Max        | Min                            | Max          | Min                     | Max        |      |
| t <sub>PLH</sub><br>t <sub>PHL</sub>   | Propagation Delay<br>Input to Output           | 1        | 1.5<br>1.5                       | 7.0<br>7.0 | 1.5<br>1.5              | 8.0<br>8.0 | 1.5<br>1.5                     | 8.4<br>8.4   | 1.5<br>1.5              | 5.0<br>5.0 | ns   |
| t <sub>PZH</sub><br>t <sub>PZL</sub>   | Output Enable Time<br>to High and Low Level    | 2        | 1.5<br>1.5                       | 8.5<br>8.5 | 1.5<br>1.5              | 9.5<br>9.5 | 1.5<br>1.5                     | 10.5<br>10.5 | 1.5<br>1.5              | 7.0<br>7.0 | ns   |
| t <sub>PHZ</sub><br>t <sub>PLZ</sub>   | Output Disable Time From<br>High and Low Level | 2        | 1.5<br>1.5                       | 7.5<br>7.5 | 1.5<br>1.5              | 8.5<br>8.5 | 1.5<br>1.5                     | 9.0<br>9.0   | 1.5<br>1.5              | 6.0<br>6.0 | ns   |
| t <sub>OSHL</sub><br>t <sub>OSLH</sub> | Output-to-Output Skew<br>(Note 3)              |          |                                  | 1.0<br>1.0 |                         | 1.0<br>1.0 |                                | 1.0<br>1.0   |                         | 1.0<br>1.0 | ns   |

3. Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t<sub>OSHL</sub>) or LOW-to-HIGH (t<sub>OSLH</sub>); parameter guaranteed by design.

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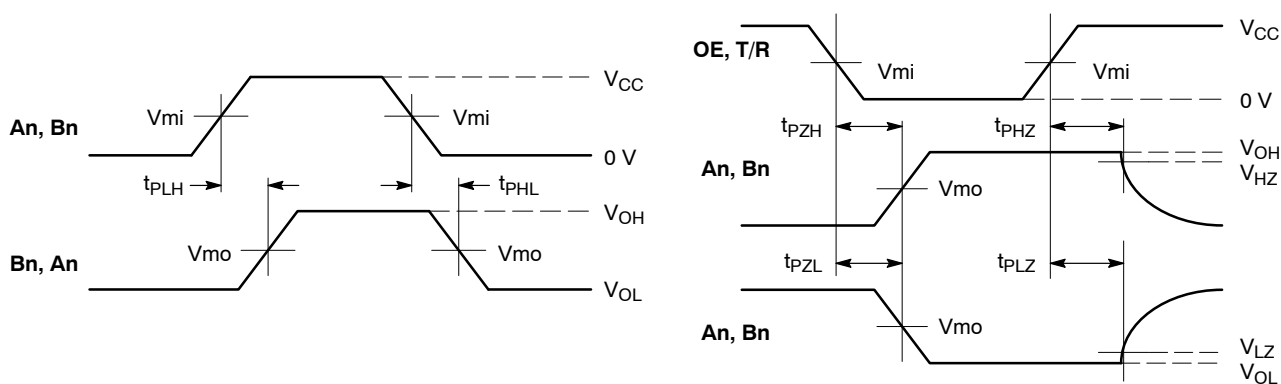
## DYNAMIC SWITCHING CHARACTERISTICS

| Symbol    | Characteristic                      | Condition                                                                                                                                                                          | $T_A = +25^{\circ}\text{C}$ |              |     | Unit   |
|-----------|-------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------|--------------|-----|--------|
|           |                                     |                                                                                                                                                                                    | Min                         | Typ          | Max |        |
| $V_{OLP}$ | Dynamic LOW Peak Voltage (Note 4)   | $V_{CC} = 3.3\text{ V}, C_L = 50\text{ pF}, V_{IH} = 3.3\text{ V}, V_{IL} = 0\text{ V}$<br>$V_{CC} = 2.5\text{ V}, C_L = 30\text{ pF}, V_{IH} = 2.5\text{ V}, V_{IL} = 0\text{ V}$ |                             | 0.8<br>0.6   |     | V<br>V |
| $V_{OLV}$ | Dynamic LOW Valley Voltage (Note 4) | $V_{CC} = 3.3\text{ V}, C_L = 50\text{ pF}, V_{IH} = 3.3\text{ V}, V_{IL} = 0\text{ V}$<br>$V_{CC} = 2.5\text{ V}, C_L = 30\text{ pF}, V_{IH} = 2.5\text{ V}, V_{IL} = 0\text{ V}$ |                             | -0.8<br>-0.6 |     | V<br>V |

4. Number of outputs defined as “n”. Measured with “n-1” outputs switching from HIGH-to-LOW or LOW-to-HIGH. The remaining output is measured in the LOW state.

## CAPACITIVE CHARACTERISTICS

| Symbol    | Parameter                     | Condition                                                    | Typical | Unit |
|-----------|-------------------------------|--------------------------------------------------------------|---------|------|
| $C_{IN}$  | Input Capacitance             | $V_{CC} = 3.3\text{ V}, V_I = 0\text{ V or } V_{CC}$         | 7       | pF   |
| $C_{I/O}$ | Input/Output Capacitance      | $V_{CC} = 3.3\text{ V}, V_I = 0\text{ V or } V_{CC}$         | 8       | pF   |
| $C_{PD}$  | Power Dissipation Capacitance | 10 MHz, $V_{CC} = 3.3\text{ V}, V_I = 0\text{ V or } V_{CC}$ | 25      | pF   |



**WAVEFORM 1 – PROPAGATION DELAYS**

$t_R = t_F = 2.5\text{ ns}$ , 10% to 90%;  $f = 1\text{ MHz}$ ;  $t_W = 500\text{ ns}$

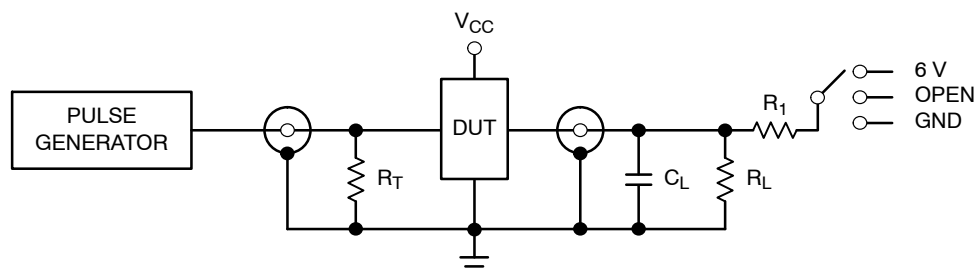
**WAVEFORM 2 – OUTPUT ENABLE AND DISABLE TIMES**

$t_R = t_F = 2.5\text{ ns}$ , 10% to 90%;  $f = 1\text{ MHz}$ ;  $t_W = 500\text{ ns}$

**Figure 3. AC Waveforms**

| Symbol   | $V_{CC}$                        |                         |                                 |                          |
|----------|---------------------------------|-------------------------|---------------------------------|--------------------------|
|          | $3.3\text{ V} \pm 0.3\text{ V}$ | $2.7\text{ V}$          | $2.5\text{ V} \pm 0.2\text{ V}$ | $5.0\text{ V}$           |
| $V_{mi}$ | 1.5 V                           | 1.5 V                   | $V_{CC}/2$                      | $V_{CC}/2$               |
| $V_{mo}$ | 1.5 V                           | 1.5 V                   | $V_{CC}/2$                      | $V_{CC}/2$               |
| $V_{HZ}$ | $V_{OL} + 0.3\text{ V}$         | $V_{OL} + 0.3\text{ V}$ | $V_{OL} + 0.15\text{ V}$        | $V_{OL} + 0.15\text{ V}$ |
| $V_{LZ}$ | $V_{OH} - 0.3\text{ V}$         | $V_{OH} - 0.3\text{ V}$ | $V_{OH} - 0.15\text{ V}$        | $V_{OH} - 0.15\text{ V}$ |

## MC74LCX245



| TEST                                         | SWITCH                                                             |
|----------------------------------------------|--------------------------------------------------------------------|
| $t_{PLH}$ , $t_{PHL}$                        | Open                                                               |
| $t_{PZL}$ , $t_{PLZ}$                        | 6 V at $V_{CC} = 3.3 \pm 0.3$ V<br>6 V at $V_{CC} = 2.5 \pm 0.2$ V |
| Open Collector/Drain $t_{PLH}$ and $t_{PHL}$ | 6 V                                                                |
| $t_{PZH}$ , $t_{PHZ}$                        | GND                                                                |

$C_L = 50$  pF at  $V_{CC} = 3.3 \pm 0.3$  V or equivalent (includes jig and probe capacitance)

$C_L = 30$  pF at  $V_{CC} = 2.5 \pm 0.2$  V or equivalent (includes jig and probe capacitance)

$R_L = R_1 = 500 \Omega$  or equivalent

$R_T = Z_{OUT}$  of pulse generator (typically  $50 \Omega$ )

Figure 4. Test Circuit

### ORDERING INFORMATION

| Device            | Package               | Shipping <sup>†</sup> |
|-------------------|-----------------------|-----------------------|
| MC74LCX245DWR2G   | SOIC-20<br>(Pb-Free)  | 1000 Tape & Reel      |
| MC74LCX245DWG     | SOIC-20<br>(Pb-Free)  | 38 Units / Rail       |
| MC74LCX245DTG     | TSSOP-20<br>(Pb-Free) | 75 Units / Rail       |
| MC74LCX245DTR2G   | TSSOP-20<br>(Pb-Free) | 2500 Tape & Reel      |
| NLV74LCX245DTR2G* | TSSOP-20<br>(Pb-Free) | 2500 Tape & Reel      |
| MC74LCX245MNTWG   | QFN20<br>(Pb-Free)    | 3000 Tape & Reel      |

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

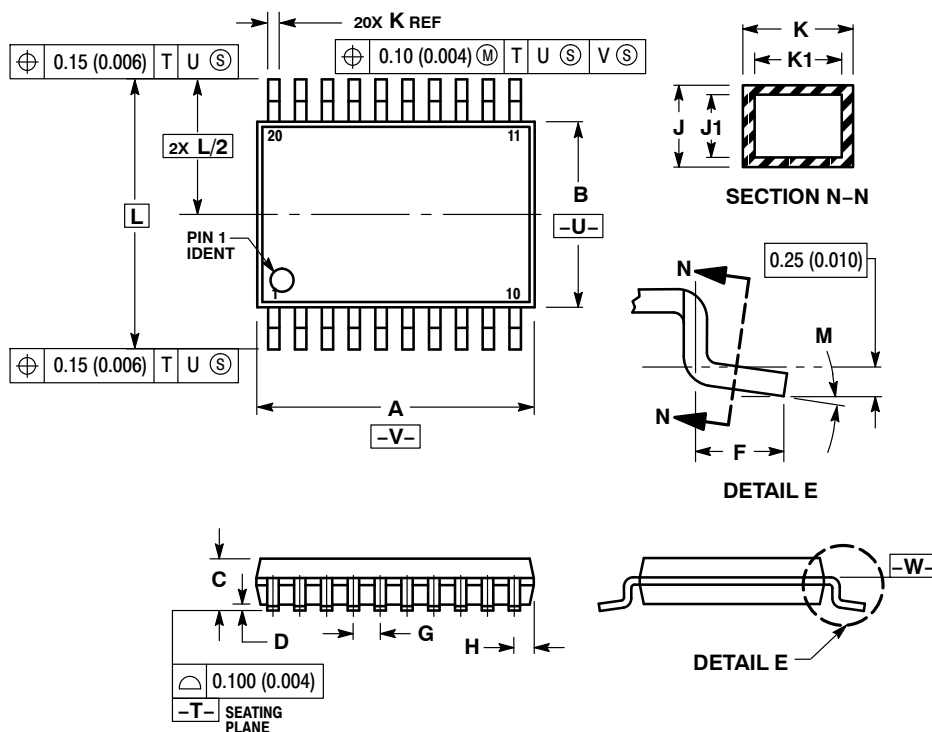
\*NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.



# MC74LCX245

## PACKAGE DIMENSIONS

TSSOP-20  
CASE 948E-02  
ISSUE C

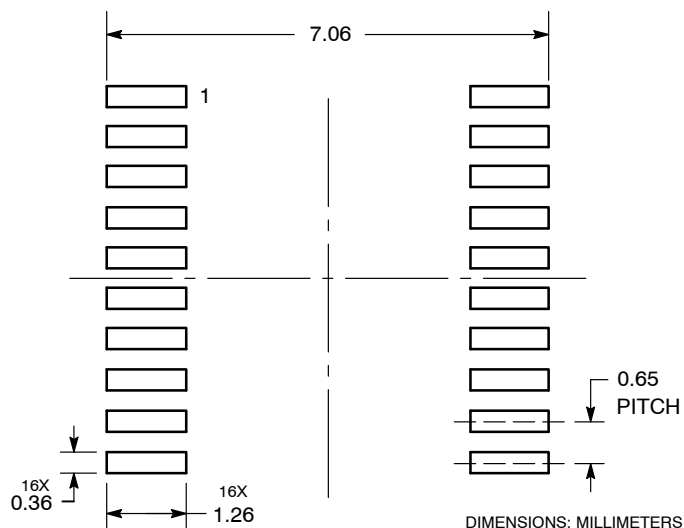


### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

| DIM | MILLIMETERS |      | INCHES    |       |
|-----|-------------|------|-----------|-------|
|     | MIN         | MAX  | MIN       | MAX   |
| A   | 6.40        | 6.60 | 0.252     | 0.260 |
| B   | 4.30        | 4.50 | 0.169     | 0.177 |
| C   | ---         | 1.20 | ---       | 0.047 |
| D   | 0.05        | 0.15 | 0.002     | 0.006 |
| F   | 0.50        | 0.75 | 0.020     | 0.030 |
| G   | 0.65 BSC    |      | 0.026 BSC |       |
| H   | 0.27        | 0.37 | 0.011     | 0.015 |
| J   | 0.09        | 0.20 | 0.004     | 0.008 |
| J1  | 0.09        | 0.16 | 0.004     | 0.006 |
| K   | 0.19        | 0.30 | 0.007     | 0.012 |
| K1  | 0.19        | 0.25 | 0.007     | 0.010 |
| L   | 6.40 BSC    |      | 0.252 BSC |       |
| M   | 0°          | 8°   | 0°        | 8°    |

### SOLDERING FOOTPRINT





Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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